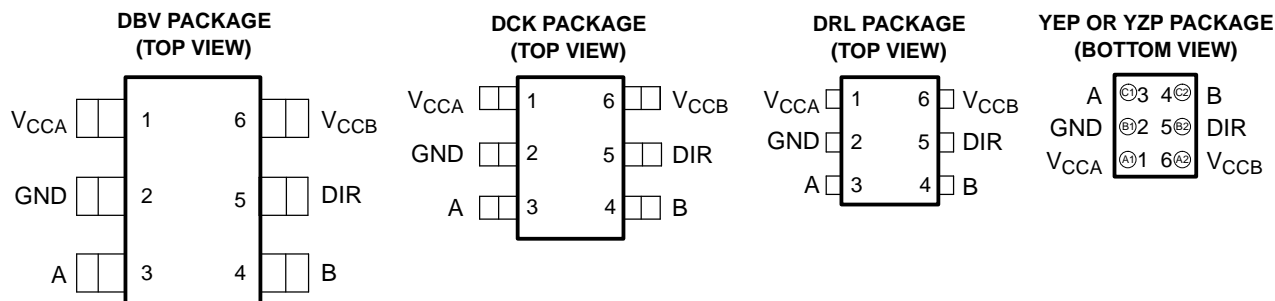


## FEATURES

- Available in the Texas Instruments NanoStar™ and NanoFree™ Packages
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- V<sub>CC</sub> Isolation Feature - If Either V<sub>CC</sub> Input Is at GND, Both Ports Are in the High-Impedance State
- DIR Input Circuit Referenced to V<sub>CCA</sub>
- ±12-mA Output Drive at 3.3 V
- I/Os Are 4.6-V Tolerant
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)



See mechanical drawings for dimensions.

## DESCRIPTION/ORDERING INFORMATION

This single-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC1T45 is optimized to operate with V<sub>CCA</sub>/V<sub>CCB</sub> set at 1.4 V to 3.6 V. It is operational with V<sub>CCA</sub>/V<sub>CCB</sub> as low as 1.2 V. The A port is designed to track V<sub>CCA</sub>. V<sub>CCA</sub> accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V<sub>CCB</sub>. V<sub>CCB</sub> accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

### ORDERING INFORMATION

T <sub>A</sub>	PACKAGE <sup>(1)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING <sup>(2)</sup>
–40°C to 85°C	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tape and reel	SN74AVC1T45YEPR	_ _ _ TC _
	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)		SN74AVC1T45YZPR	
	SOT (SOT-23) – DBV	Tape and reel	SN74AVC1T45DBVR	DT1 _
	SOT (SC-70) – DCK	Tape and reel	SN74AVC1T45DCKR	TC _
	SOT (SOT-553) – DRL	Reel of 4000	SN74AVC1T45DRLR	UE _

- Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).
- DBV/DCK/DRL: The actual top-side marking has one additional character that designates the assembly/test site.  
YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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# SN74AVC1T45

## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

## DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74AVC1T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess  $I_{CC}$  and  $I_{CCZ}$ .

The SN74AVC1T45 is designed so that the DIR input is powered by  $V_{CCA}$ .

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either  $V_{CC}$  input is at GND, then both ports are in the high-impedance state.

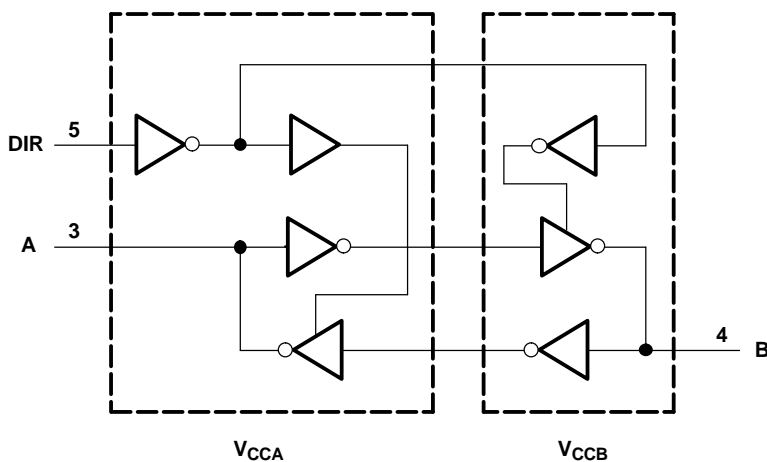
NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

**FUNCTION TABLE<sup>(1)</sup>**

INPUT DIR	OPERATION
L	B data to A bus
H	A data to B bus

(1) Input circuits of the data I/Os always are active.

**LOGIC DIAGRAM (POSITIVE LOGIC)**



## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
$V_{CCA}$ $V_{CCB}$	Supply voltage range		–0.5	4.6	V
$V_I$	Input voltage range <sup>(2)</sup>	I/O ports (A port)	–0.5	4.6	V
		I/O ports (B port)	–0.5	4.6	
		Control inputs	–0.5	4.6	
$V_O$	Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup>	A port	–0.5	4.6	V
		B port	–0.5	4.6	
$V_O$	Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>	A port	–0.5	$V_{CCA} + 0.5$	V
		B port	–0.5	$V_{CCB} + 0.5$	
$I_{IK}$	Input clamp current	$V_I < 0$		–50	mA
$I_{OK}$	Output clamp current	$V_O < 0$		–50	mA
$I_O$	Continuous output current			±50	mA
	Continuous current through $V_{CCA}$ , $V_{CCB}$ , or GND			±100	mA
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DBV package		165	°C/W
		DCK package		259	
		DRL package		142	
		YEP/YZP package		123	
$T_{stg}$	Storage temperature range		–65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current ratings are observed.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

# SN74AVC1T45

## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

#### Recommended Operating Conditions<sup>(1)(2)(3)</sup>

			V <sub>CCI</sub>	V <sub>CCO</sub>	MIN	MAX	UNIT
V <sub>CCA</sub>	Supply voltage				1.2	3.6	V
V <sub>CCB</sub>	Supply voltage				1.2	3.6	V
V <sub>IH</sub>	High-level input voltage	Data inputs	1.2 V to 1.95 V		V <sub>CCI</sub> × 0.65		V
			1.95 V to 2.7 V		1.6		
			2.7 V to 3.6 V		2		
V <sub>IL</sub>	Low-level input voltage	Data inputs	1.2 V to 1.95 V		V <sub>CCI</sub> × 0.35		V
			1.95 V to 2.7 V		0.7		
			2.7 V to 3.6 V		0.8		
V <sub>IH</sub>	High-level input voltage	DIR (referenced to V <sub>CCA</sub> )	1.2 V to 1.95 V		V <sub>CCA</sub> × 0.65		V
			1.95 V to 2.7 V		1.6		
			2.7 V to 3.6 V		2		
V <sub>IL</sub>	Low-level input voltage	DIR (referenced to V <sub>CCA</sub> )	1.2 V to 1.95 V		V <sub>CCA</sub> × 0.35		V
			1.95 V to 2.7 V		0.7		
			2.7 V to 3.6 V		0.8		
V <sub>I</sub>	Input voltage				0	3.6	V
V <sub>O</sub>	Output voltage	Active state			0	V <sub>CCO</sub>	V
		3-state			0	3.6	
I <sub>OH</sub>	High-level output current			1.2 V		–3	mA
				1.4 V to 1.6 V		–6	
				1.65 V to 1.95 V		–8	
				2.3 V to 2.7 V		–9	
				3 V to 3.6 V		–12	
I <sub>OL</sub>	Low-level output current			1.2 V		3	mA
				1.4 V to 1.6 V		6	
				1.65 V to 1.95 V		8	
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δv	Input transition rise or fall rate					5	ns/V
T <sub>A</sub>	Operating free-air temperature				–40	85	°C

(1) V<sub>CCI</sub> is the V<sub>CC</sub> associated with the input port.

(2) V<sub>CCO</sub> is the V<sub>CC</sub> associated with the output port.

(3) All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## Electrical Characteristics<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	T <sub>A</sub> = 25°C			–40°C to 85°C		UNIT
					MIN	TYP	MAX	MIN	MAX	
V <sub>OH</sub>		I <sub>OH</sub> = –100 μA	V <sub>I</sub> = V <sub>IH</sub>	1.2 V to 3.6 V	1.2 V to 3.6 V				V <sub>CCO</sub> – 0.2 V	V
		I <sub>OH</sub> = –3 mA		1.2 V	1.2 V	0.95				
		I <sub>OH</sub> = –6 mA		1.4 V	1.4 V				1.05	
		I <sub>OH</sub> = –8 mA		1.65 V	1.65 V				1.2	
		I <sub>OH</sub> = –9 mA		2.3 V	2.3 V				1.75	
		I <sub>OH</sub> = –12 mA		3 V	3 V				2.3	
V <sub>OL</sub>		I <sub>OL</sub> = 100 μA	V <sub>I</sub> = V <sub>IL</sub>	1.2 V to 3.6 V	1.2 V to 3.6 V				0.2	V
		I <sub>OL</sub> = 3 mA		1.2 V	1.2 V	0.15				
		I <sub>OL</sub> = 6 mA		1.4 V	1.4 V				0.35	
		I <sub>OL</sub> = 8 mA		1.65 V	1.65 V				0.45	
		I <sub>OL</sub> = 9 mA		2.3 V	2.3 V				0.55	
		I <sub>OL</sub> = 12 mA		3 V	3 V				0.7	
I <sub>I</sub>	DIR	V <sub>I</sub> = V <sub>CCA</sub> or GND	1.2 V to 3.6 V	1.2 V to 3.6 V	±0.025	±0.25			±1	μA
I <sub>off</sub>	A port	V <sub>I</sub> or V <sub>O</sub> = 0 to 3.6 V	0 V	0 to 3.6 V	±0.1	±1			±5	μA
	B port		0 to 3.6 V	0 V	±0.1	±1			±5	
I <sub>OZ</sub>	A or B port	V <sub>O</sub> = V <sub>CCO</sub> or GND	1.2 V to 3.6 V	1.2 V to 3.6 V	±0.5	±2.5			±5	μA
I <sub>CCA</sub>		V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0	1.2 V to 3.6 V	1.2 V to 3.6 V				10	μA	
			0 V	3.6 V				–2		
			3.6 V	0 V				10		
I <sub>CCB</sub>		V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0	1.2 V to 3.6 V	1.2 V to 3.6 V				10	μA	
			0 V	3.6 V				10		
			3.6 V	0 V				–2		
I <sub>CCA</sub> + I <sub>CCB</sub> (see Table 1)		V <sub>I</sub> = V <sub>CCI</sub> or GND, I <sub>O</sub> = 0	1.2 V to 3.6 V	1.2 V to 3.6 V				20	μA	
C <sub>i</sub>	Control inputs	V <sub>I</sub> = 3.3 V or GND	3.3 V	3.3 V	2.5					pF
C <sub>io</sub>	A or B port	V <sub>O</sub> = 3.3 V or GND	3.3 V	3.3 V	6					pF

(1)  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

(2)  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.

# SN74AVC1T45

## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

#### Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 1.2\text{ V}$  (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2\text{ V}$	$V_{CCB} = 1.5\text{ V}$	$V_{CCB} = 1.8\text{ V}$	$V_{CCB} = 2.5\text{ V}$	$V_{CCB} = 3.3\text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
$t_{PLH}$	A	B	3.3	2.7	2.4	2.3	2.4	ns
$t_{PHL}$			3.3	2.7	2.4	2.3	2.4	
$t_{PLH}$	B	A	3.3	3.1	2.9	2.8	2.7	ns
$t_{PHL}$			3.3	3.1	2.9	2.8	2.7	
$t_{PHZ}$	DIR	A	5.1	5.2	5.3	5.2	3.7	ns
$t_{PLZ}$			5.1	5.2	5.3	5.2	3.7	
$t_{PHZ}$	DIR	B	5.3	4.3	4	3.3	3.7	ns
$t_{PLZ}$			5.3	4.3	4	3.3	3.7	
$t_{PZH}^{(1)}$	DIR	A	8.6	7.3	6.8	6.1	6.4	ns
$t_{PZL}^{(1)}$			8.6	7.3	6.8	6.1	6.4	
$t_{PZH}^{(1)}$	DIR	B	8.3	7.8	7.7	7.5	5.8	ns
$t_{PZL}^{(1)}$			8.3	7.8	7.7	7.5	5.8	

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

#### Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 1.5\text{ V} \pm 0.1\text{ V}$  (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2\text{ V}$	$V_{CCB} = 1.5\text{ V} \pm 0.1\text{ V}$		$V_{CCB} = 1.8\text{ V} \pm 0.15\text{ V}$		$V_{CCB} = 2.5\text{ V} \pm 0.2\text{ V}$		$V_{CCB} = 3.3\text{ V} \pm 0.3\text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A	B	2.9	0.7	5.6	0.6	5.2	0.5	4.2	0.5	3.8	ns
$t_{PHL}$			2.9	0.7	5.6	0.6	5.2	0.5	4.2	0.5	3.8	
$t_{PLH}$	B	A	2.6	0.6	5.5	0.4	5.3	0.3	4.9	0.3	4.8	ns
$t_{PHL}$			2.6	0.6	5.5	0.4	5.3	0.3	4.9	0.3	4.8	
$t_{PHZ}$	DIR	A	3.8	1.6	6.7	1.5	6.8	0.3	6.9	0.9	6.9	ns
$t_{PLZ}$			3.8	1.6	6.7	1.5	6.8	0.3	6.9	0.9	6.9	
$t_{PHZ}$	DIR	B	5.1	1.8	8.1	1.6	7.1	1.1	4.7	1.4	4.5	ns
$t_{PLZ}$			5.1	1.8	8.1	1.6	7.1	1.1	4.7	1.4	4.5	
$t_{PZH}^{(1)}$	DIR	A	7.7		13.6		12.4		9.6		9.3	ns
$t_{PZL}^{(1)}$			7.7		13.6		12.4		9.6		9.3	
$t_{PZH}^{(1)}$	DIR	B	6.7		12.3		12		11.1		10.7	ns
$t_{PZL}^{(1)}$			6.7		12.3		12		11.1		10.7	

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$  (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A	B	2.7	0.6	5.3	0.5	5	0.4	3.9	0.4	3.4	ns
$t_{PHL}$			2.7	0.6	5.3	0.5	5	0.4	3.9	0.4	3.4	
$t_{PLH}$	B	A	2.3	0.5	5.2	0.4	5	0.3	4.6	0.2	4.4	ns
$t_{PHL}$			2.3	0.5	5.2	0.4	5	0.3	4.6	0.2	4.4	
$t_{PHZ}$	DIR	A	3.8	1.6	5.9	1.6	5.9	1.6	5.9	0.5	6	ns
$t_{PLZ}$			3.8	1.6	5.9	1.6	5.9	1.6	5.9	0.5	6	
$t_{PHZ}$	DIR	B	5	1.8	7.7	1.4	6.8	1	4.4	1.4	5.3	ns
$t_{PLZ}$			5	1.8	7.7	1.4	6.8	1	4.4	1.4	5.3	
$t_{PZH}^{(1)}$	DIR	A	7.3		12.9		11.8		9		8.7	ns
$t_{PZL}^{(1)}$			7.3		12.9		11.8		9		8.7	
$t_{PZH}^{(1)}$	DIR	B	6.5		11.2		10.9		9.8		9.4	ns
$t_{PZL}^{(1)}$			6.5		11.2		10.9		9.8		9.4	

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A	B	2.6	0.5	4.9	0.4	4.6	0.3	3.4	0.3	3	ns
$t_{PHL}$			2.6	0.5	4.9	0.4	4.6	0.3	3.4	0.3	3	
$t_{PLH}$	B	A	2.2	0.4	4.2	0.3	3.8	0.2	3.4	0.2	3.3	ns
$t_{PHL}$			2.2	0.4	4.2	0.3	3.8	0.2	3.4	0.2	3.3	
$t_{PHZ}$	DIR	A	2.8	0.3	3.8	0.8	3.8	0.4	3.8	0.5	3.8	ns
$t_{PLZ}$			2.8	0.3	3.8	0.8	3.8	0.4	3.8	0.5	3.8	
$t_{PHZ}$	DIR	B	4.9	2	7.6	1.5	6.5	0.6	4.1	1	4	ns
$t_{PLZ}$			4.9	2	7.6	1.5	6.5	0.6	4.1	1	4	
$t_{PZH}^{(1)}$	DIR	A	7.1		11.8		10.3		7.5		7.3	ns
$t_{PZL}^{(1)}$			7.1		11.8		10.3		7.5		7.3	
$t_{PZH}^{(1)}$	DIR	B	5.4		8.6		8.1		7		6.6	ns
$t_{PZL}^{(1)}$			5.4		8.6		8.1		7		6.6	

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

# SN74AVC1T45

## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

## Switching Characteristics

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (see [Figure 1](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CCB} = 1.2 \text{ V}$	$V_{CCB} = 1.5 \text{ V} \pm 0.1 \text{ V}$		$V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$		$V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$		$V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT
			TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{PLH}$	A	B	2.6	0.4	4.7	0.3	4.4	0.2	3.3	0.2	2.8	ns
$t_{PHL}$			2.6	0.4	4.7	0.3	4.4	0.2	3.3	0.2	2.8	
$t_{PLH}$	B	A	2.2	0.4	3.8	0.3	3.4	0.2	3	0.1	2.8	ns
$t_{PHL}$			2.2	0.4	3.8	0.3	3.4	0.2	3	0.1	2.8	
$t_{PHZ}$	DIR	A	3.1	1.3	4.3	1.3	4.3	1.3	4.3	1.3	4.3	ns
$t_{PLZ}$			3.1	1.3	4.3	1.3	4.3	1.3	4.3	1.3	4.3	
$t_{PHZ}$	DIR	B	4	0.7	7.4	0.6	6.5	0.7	4	1.5	4.9	ns
$t_{PLZ}$			4	0.7	7.4	0.6	6.5	0.7	4	1.5	4.9	
$t_{PZH}^{(1)}$	DIR	A	6.2		11.2		9.9		7		6.7	ns
$t_{PZL}^{(1)}$			6.2		11.2		9.9		7		6.7	
$t_{PZH}^{(1)}$	DIR	B	5.7		8.9		8.5		7.2		6.8	ns
$t_{PZL}^{(1)}$			5.7		8.9		8.5		7.2		6.8	

(1) The enable time is a calculated value, derived using the formula shown in the *enable times* section.

## Operating Characteristics

$T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	$V_{CCA} =$ $V_{CCB} = 1.2 \text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.5 \text{ V}$	$V_{CCA} =$ $V_{CCB} = 1.8 \text{ V}$	$V_{CCA} =$ $V_{CCB} = 2.5 \text{ V}$	$V_{CCA} =$ $V_{CCB} = 3.3 \text{ V}$	UNIT
			TYP	TYP	TYP	TYP	TYP	
$C_{pdA}^{(1)}$	A-port input, B-port output	$C_L = 0 \text{ pF},$ $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	3	3	3	3	4	pF
	B-port input, A-port output		13	13	14	15	15	
$C_{pdB}^{(1)}$	A-port input, B-port output	$C_L = 0 \text{ pF},$ $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$	13	13	14	15	15	pF
	B-port input, A-port output		3	3	3	3	3	

(1) Power dissipation capacitance per transceiver



## Power-Up Considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

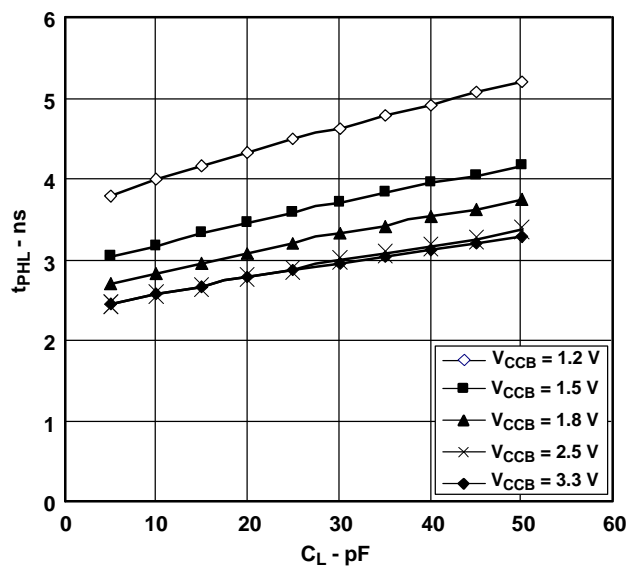
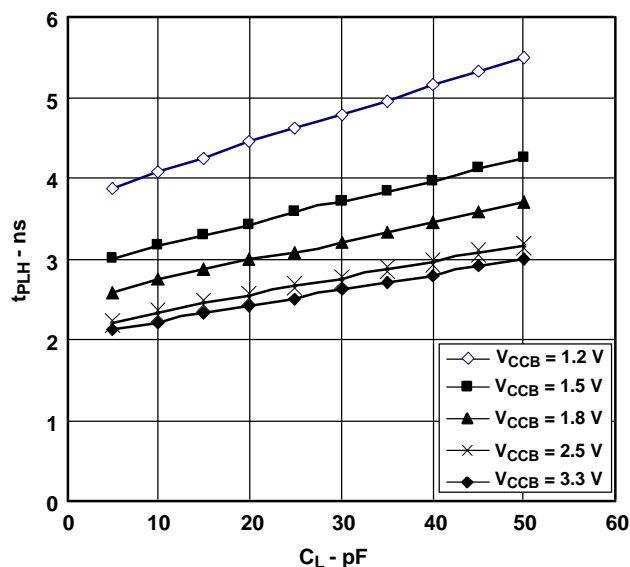
1. Connect ground before any supply voltage is applied.
2. Power up  $V_{CCA}$ .
3.  $V_{CCB}$  can be ramped up along with or after  $V_{CCA}$ .

**Table 1. Typical Total Static Power Consumption ( $I_{CCA} + I_{CCB}$ )**

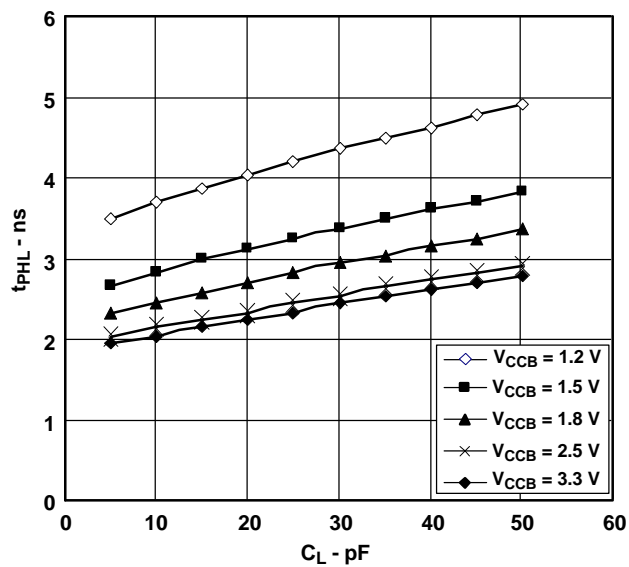
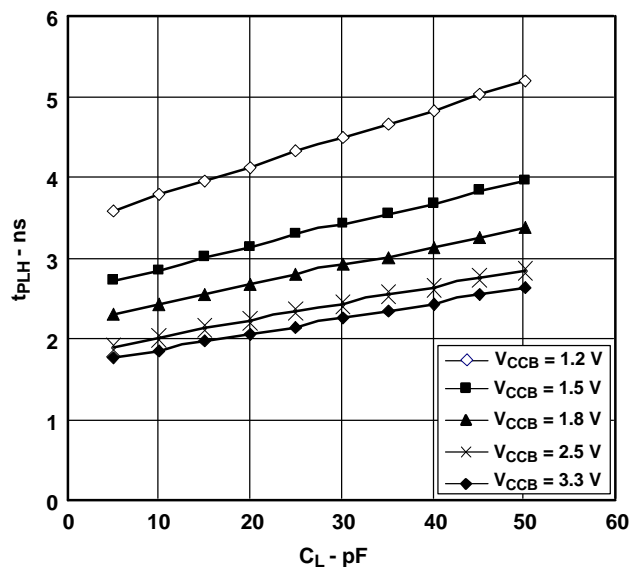
$V_{CCB}$	$V_{CCA}$						UNIT
	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
0 V	0	<0.5	<0.5	<0.5	<0.5	<0.5	$\mu\text{A}$
1.2 V	<0.5	<1	<1	<1	<1	1	
1.5 V	<0.5	<1	<1	<1	<1	1	
1.8 V	<0.5	<1	<1	<1	<1	<1	
2.5 V	<0.5	1	<1	<1	<1	<1	
3.3 V	<0.5	1	<1	<1	<1	<1	

## TYPICAL CHARACTERISTICS

**TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,**  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.2\text{ V}$

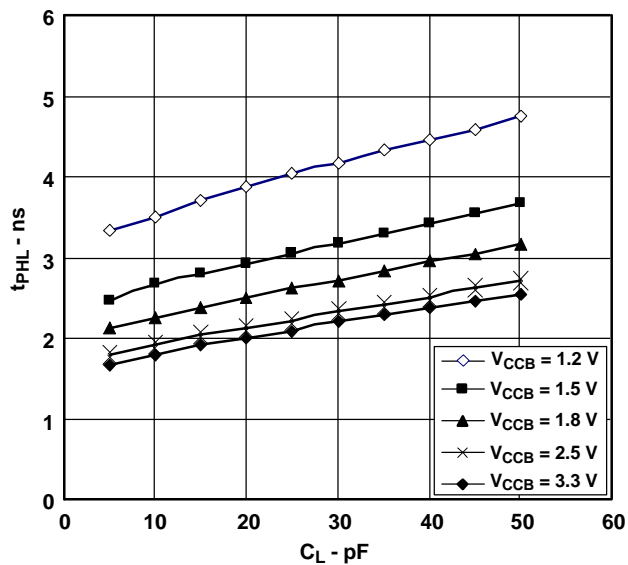
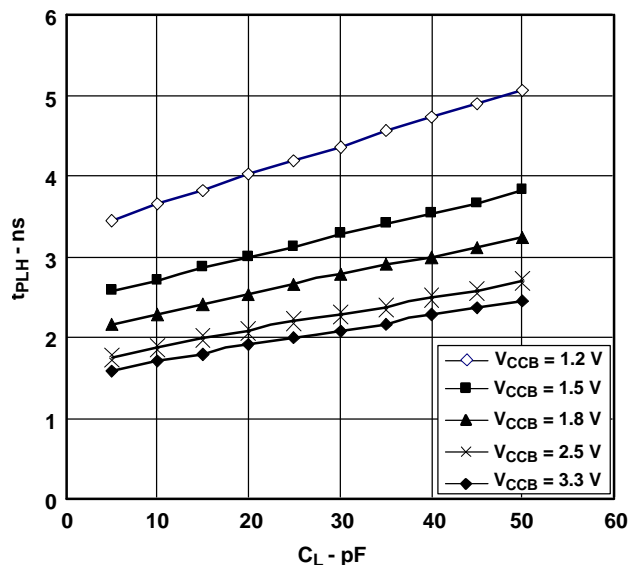


**TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,**  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.5\text{ V}$

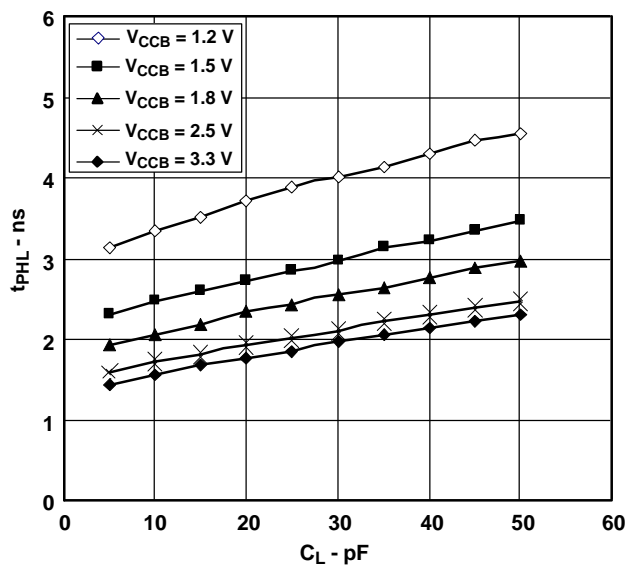
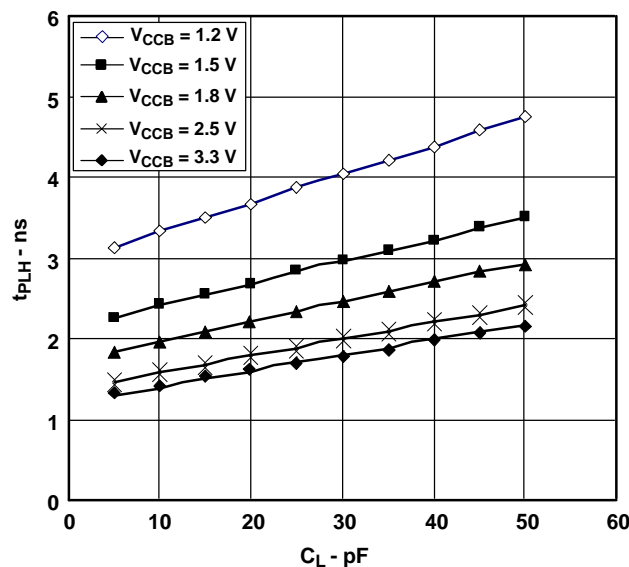


# TYPICAL CHARACTERISTICS

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 1.8\text{ V}$



TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 2.5\text{ V}$



# SN74AVC1T45

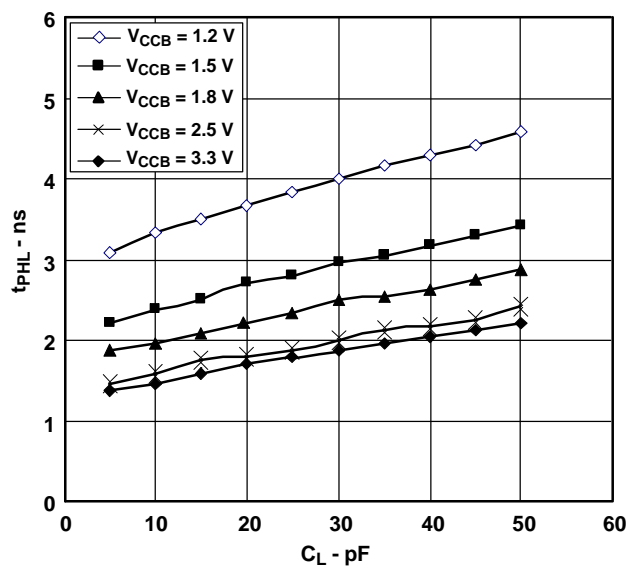
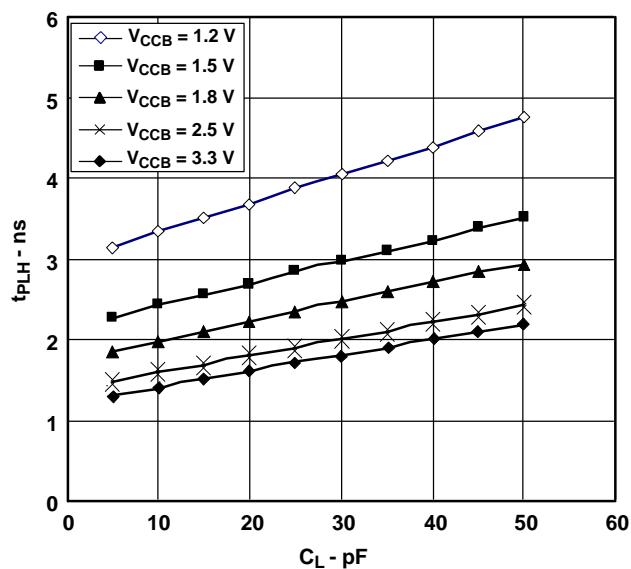
## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

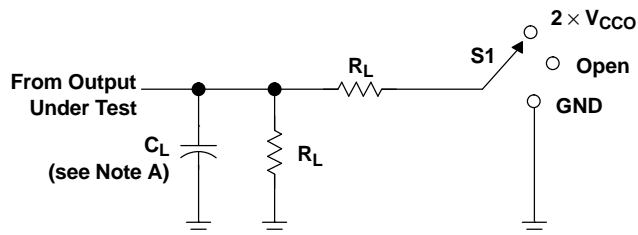
SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

## TYPICAL CHARACTERISTICS

**TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE,**  
 $T_A = 25^\circ\text{C}$ ,  $V_{CCA} = 3.3\text{ V}$



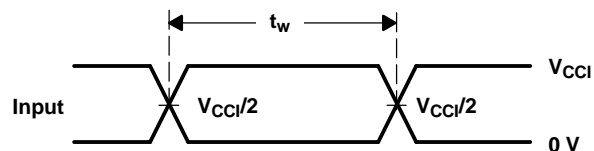
## PARAMETER MEASUREMENT INFORMATION



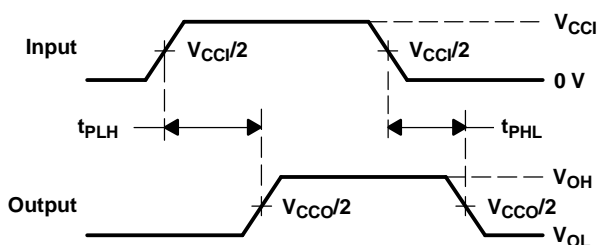
LOAD CIRCUIT

$V_{CCO}$	$C_L$	$R_L$	$V_{TP}$
1.2 V	15 pF	2 k $\Omega$	0.1 V
1.5 V $\pm$ 0.1 V	15 pF	2 k $\Omega$	0.1 V
1.8 V $\pm$ 0.15 V	15 pF	2 k $\Omega$	0.15 V
2.5 V $\pm$ 0.2 V	15 pF	2 k $\Omega$	0.15 V
3.3 V $\pm$ 0.3 V	15 pF	2 k $\Omega$	0.3 V

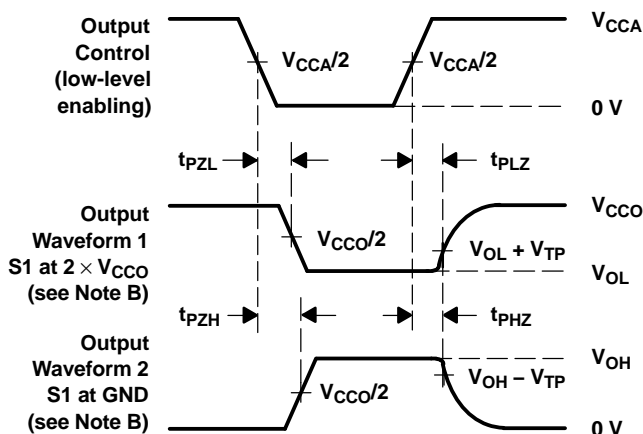
TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	$2 \times V_{CCO}$
$t_{PHZ}/t_{PZH}$	GND



VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50 \Omega$ ,  $dv/dt \geq 1$  V/ns.
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
  - $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

Figure 1. Load Circuit and Voltage Waveforms

# SN74AVC1T45

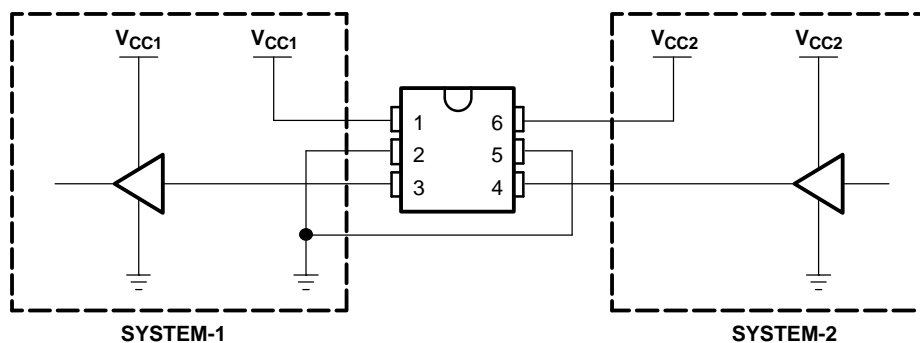
## SINGLE-BIT DUAL-SUPPLY BUS TRANSCEIVER

### WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES530D–DECEMBER 2003–REVISED NOVEMBER 2005

#### APPLICATION INFORMATION

Figure 2 shows an example of the SN74AVC1T45 being used in a unidirectional logic level-shifting application.

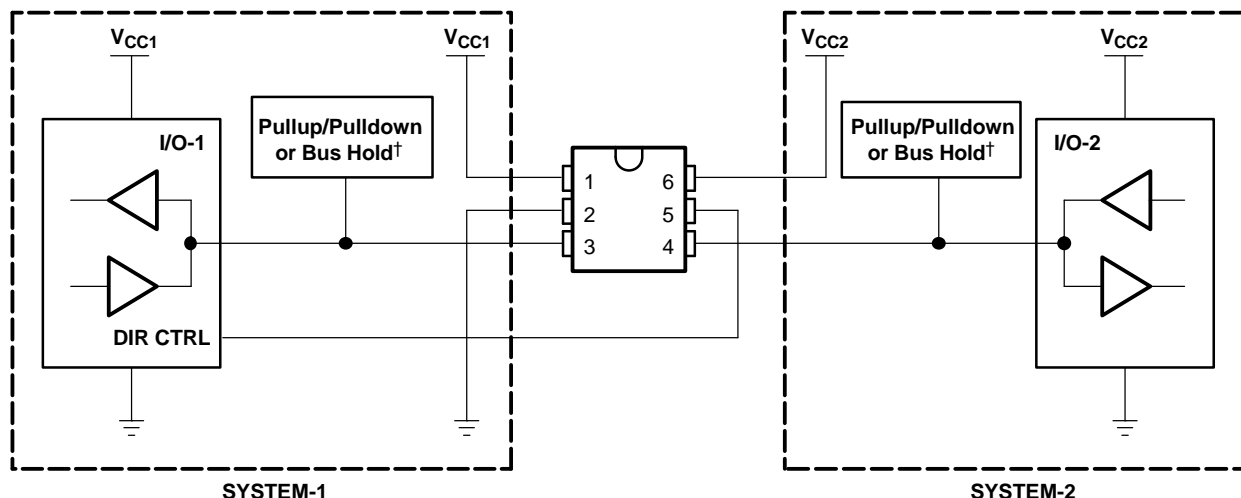


PIN	NAME	FUNCTION	DESCRIPTION
1	V <sub>CCA</sub>	V <sub>CC1</sub>	SYSTEM-1 supply voltage (1.2 V to 3.6 V)
2	GND	GND	Device GND
3	A	OUT	Output level depends on V <sub>CC1</sub> voltage.
4	B	IN	Input threshold value depends on V <sub>CC2</sub> voltage.
5	DIR	DIR	GND (low level) determines B-port to A-port direction.
6	V <sub>CCB</sub>	V <sub>CC2</sub>	SYSTEM-2 supply voltage (1.2 V to 3.6 V)

**Figure 2. Unidirectional Logic Level-Shifting Application**

## APPLICATION INFORMATION

Figure 3 shows the SN74AVC1T45 being used in a bidirectional logic level-shifting application. Since the SN74AVC1T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.



The following table shows data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

STATE	DIR CTRL	I/O-1	I/O-2	DESCRIPTION
1	H	Out	In	SYSTEM-1 data to SYSTEM-2
2	H	Hi-Z	Hi-Z	SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup>
3	L	Hi-Z	Hi-Z	DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. <sup>(1)</sup>
4	L	Out	In	SYSTEM-2 data to SYSTEM-1

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

**Figure 3. Bidirectional Logic Level-Shifting Application**

## Enable Times

Calculate the enable times for the SN74AVC1T45 using the following formulas:

- $t_{PZH} \text{ (DIR to A)} = t_{PLZ} \text{ (DIR to B)} + t_{PLH} \text{ (B to A)}$
- $t_{PZL} \text{ (DIR to A)} = t_{PHZ} \text{ (DIR to B)} + t_{PHL} \text{ (B to A)}$
- $t_{PZH} \text{ (DIR to B)} = t_{PLZ} \text{ (DIR to A)} + t_{PLH} \text{ (A to B)}$
- $t_{PZL} \text{ (DIR to B)} = t_{PHZ} \text{ (DIR to A)} + t_{PHL} \text{ (A to B)}$

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC1T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74AVC1T45DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DBVRE4	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DBVT	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DBVTE4	ACTIVE	SOT-23	DBV	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DCKR	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DCKRE4	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DCKT	ACTIVE	SC70	DCK	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DCKTE4	ACTIVE	SC70	DCK	6	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC1T45DRLR	ACTIVE	SOP	DRL	6	4000	Green (RoHS & no Sb/Br)	Call TI	Level-1-260C-UNLIM
SN74AVC1T45YEPR	ACTIVE	WCSP	YEP	6	3000	TBD	SNPB	Level-1-260C-UNLIM
SN74AVC1T45YZPR	ACTIVE	WCSP	YZP	6	3000	Pb-Free (RoHS)	SNAGCU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

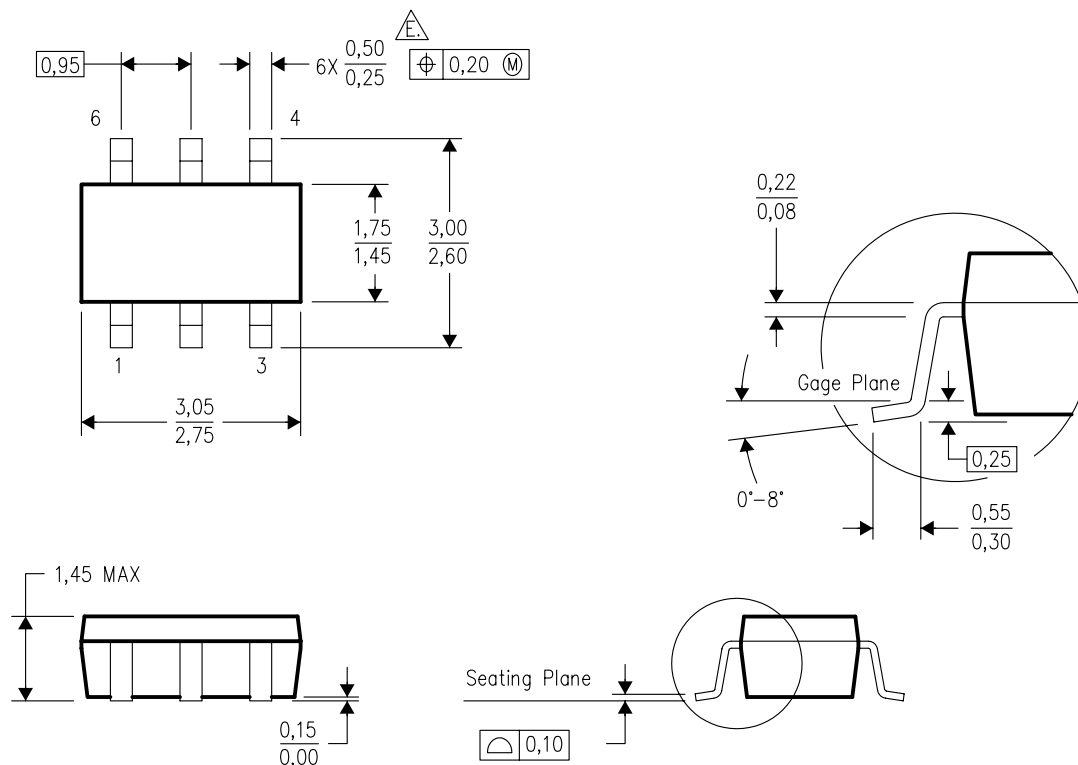
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## DBV (R-PDSO-G6)

## PLASTIC SMALL-OUTLINE PACKAGE

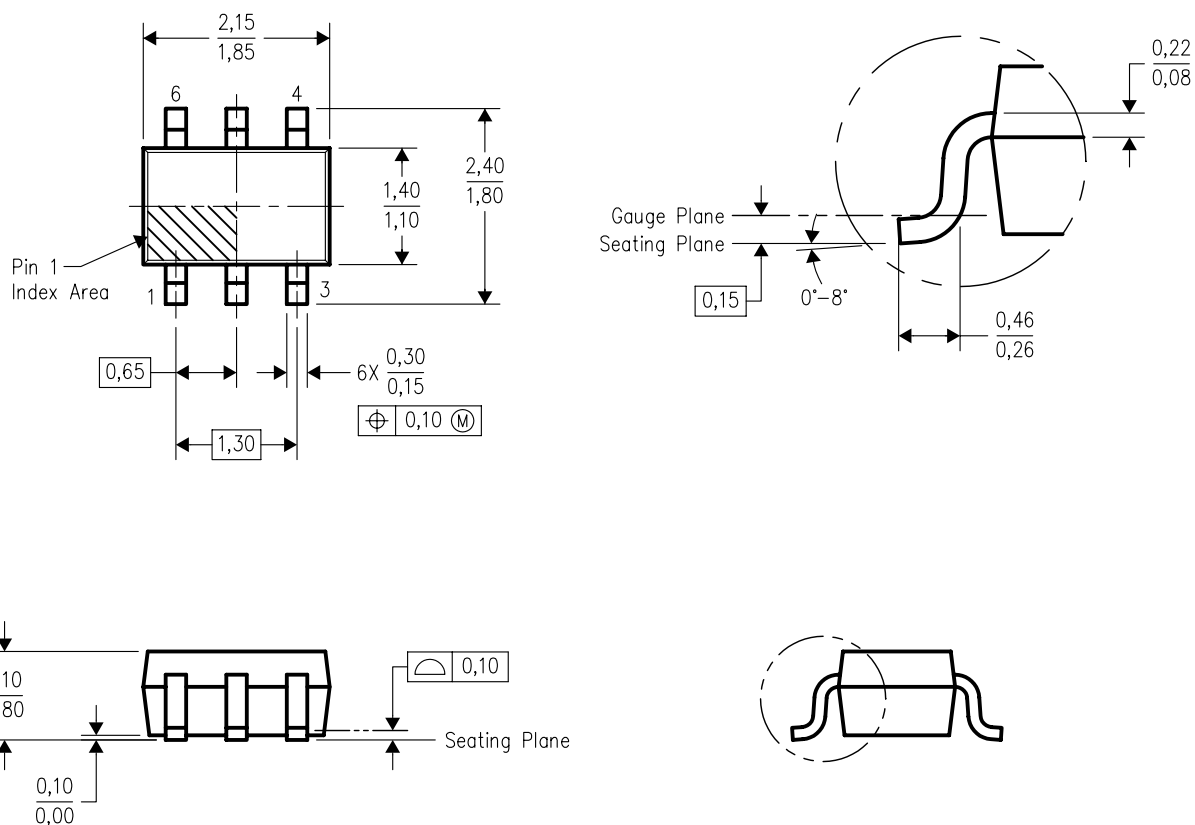


4073253-5/J 10/2005

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
-  Falls within JEDEC MO-178 Variation AB, except minimum lead width.

## DCK (R-PDSO-G6)

## PLASTIC SMALL-OUTLINE PACKAGE

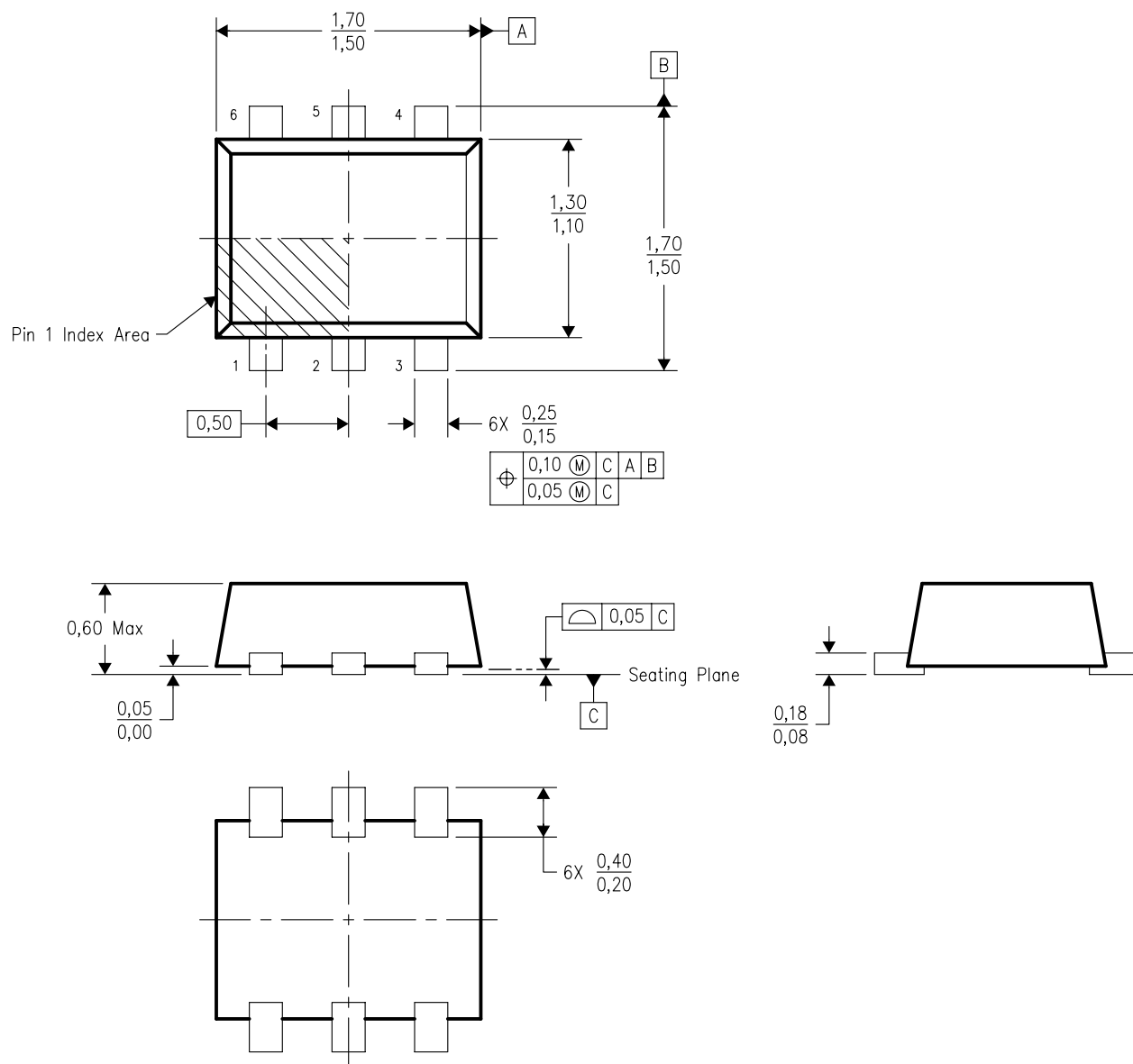


4093553-3/E 10/2005

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  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-203 variation AB.

## DRL (R-PDSO-N6)

## PLASTIC SMALL OUTLINE

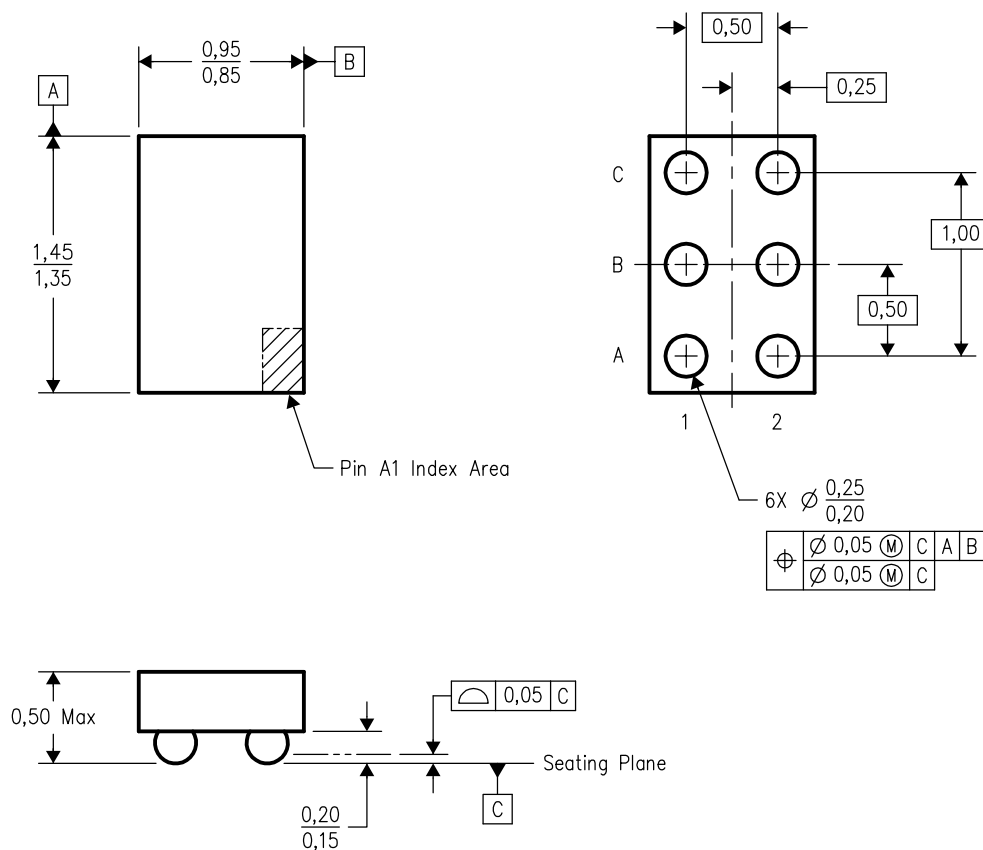


4205622-3/B 07/2004

- NOTES:
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  - B. This drawing is subject to change without notice.
  - C. JEDEC package registration is pending.

## YZP (R-XBGA-N6)

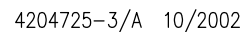
## DIE-SIZE BALL GRID ARRAY



4204741-3/A 10/2002

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. NanoFree™ package configuration.
  - D. This package is lead-free. Refer to the 6 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.



A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. NanoStar™ package configuration.  
D. This package is tin-lead (SnPb). Refer to the 6 YZP package (drawing 4204741) for lead-free.

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